

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L6	6	(29/601,602.1).ccls. and (chip near inductor) and coil and substrate and wire	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/12 13:16
L8	1	(29/605,606,830,846).ccls. and (chip near inductor) and coil and substrate and wire	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/12 13:18
L10	1	(336/200,223,232).ccls. and (chip adj coil) and substrate and wire and (protect\$3 adj (layer or coating))	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/12 13:19
L11	20	(336/200,223,232).ccls. and (coil) and substrate and wire and (protect\$3 adj (layer or coating))	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/12 13:19
L14	12	(336/200,223,232).ccls. and (inductor) and coil and substrate and wire and (protect\$3 adj (layer or coating))	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/12 13:21
L15	2	(29/601,602.1,605,606,830,846,872).ccls. and (inductor) and coil and substrate and wire and (protect\$3 adj (layer or coating))	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/12 13:21
S1	26	(shoji-shigeru).in.	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/09 12:23
S2	1	(shoji-shigeru).in. and (coil adj chip)	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/09 12:23
S3	1	("6239204").PN.	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/08/11 08:23
S4	3	((("5503286") or ("5268072") or ("5277756"))).PN.	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/08/11 09:04
S5	57319	waveguide	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/11 09:05
S6	3033	waveguide with groove	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/11 09:05
S7	199	waveguide with groove same resin	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/11 09:09
S8	6	(microwave near waveguide) with groove	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/11 09:09

S9	0	(osamu-kano).in.	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/11 09:38
S10	0	(takashi-makita).in.	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/11 09:38
S11	0	(atsuo-senda).in.	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/11 09:38
S12	11	(kano-osamu).in.	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/11 10:05
S13	32	(29/872).cccls. and coil	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/11 10:05
S14	17	(29/872).cccls. and coil and cut\$4	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/11 10:09
S15	6678	("29"/\$).cccls. and coil and cut\$4	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/11 10:09
S16	348	("29"/\$).cccls. and coil with substrate and cut\$4	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/11 10:10
S17	153	("29"/\$).cccls. and coil with substrate and wire and cut\$4	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/11 10:10
S18	62	("29"/\$).cccls. and (coil with substrate) and wire and (cut\$4 with substrate)	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/12 11:57
S19	8	("3372358"   "4012703"   "4253231"   "4873757"   "5173678"   "5929733"   "6000128").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/08/11 10:13
S20	280	resin and (coil with substrate) and wire and (cut\$4 with substrate)	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/11 10:25
S21	8	("3372358"   "4012703"   "4253231"   "4873757"   "5173678"   "5929733"   "6000128").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/08/11 12:06
S22	17	(chip adj coil) and substrate and wire and (cut\$4 with substrate)	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/12 12:01
S23	13	(chip adj coil) and substrate and wire and (protective adj (layer or coating))	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/12 13:18

S24	3	(chip near inductor) and coil and substrate and wire and (protective adj (layer or coating))	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/12 13:16
S25	224	(inductor) and coil and substrate and wire and (protective adj (layer or coating))	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/12 12:03
S26	104	(inductor) with coil and substrate and wire and (protective adj (layer or coating))	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/12 12:04
S27	50	(inductor) with coil same substrate and wire and (protective adj (layer or coating))	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/12 12:06
S28	151	(inductor) with coil and wire and (protective adj (layer or coating))	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/08/12 12:06